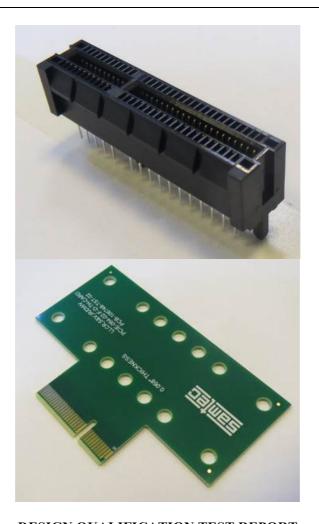


Project Number: Design Qualification Test Report	Tracking Code: 478081_Report_Rev_1
Requested by: Catie Eichhorn	Date: 6/3/2015
Part #: PCIE-064-02-F-D-TH/EDGE CARD	
Part description: PCIE/CARD	Tech: Kason He
Test Start: 3/23/2015	Test Completed: 5/27/2015



DESIGN QUALIFICATION TEST REPORT
PCIE/CARD
PCIE-064-02-F-D-TH/EDGE CARD

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD
Part description: PCIE/CARD	

REVISION HISTORY

DATE	REV.NUM.	DESCRIPTION	ENG
6/3/2015	1	Initial Issue	KH

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD
Part description: PCIE/CARD	

CERTIFICATION

All instruments and measuring equipment were calibrated to National Institute for Standards and Technology (NIST) traceable standards according to ISO 10012-1 and ANSI/NCSL 2540-1, as applicable.

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SCOPE

To perform the following tests: Design Qualification test. Please see test plan.

APPLICABLE DOCUMENTS

Standards: EIA Publication 364

TEST SAMPLES AND PREPARATION

- 1) All materials were manufactured in accordance with the applicable product specification.
- 2) All test samples were identified and encoded to maintain traceability throughout the test sequences.
- 3) After soldering, the parts to be used for LLCR testing were cleaned according to TLWI-0001.
- 4) Either an automated cleaning procedure or an ultrasonic cleaning procedure may be used.
- 5) The automated procedure is used with aqueous compatible soldering materials.
- 6) Parts not intended for testing LLCR are visually inspected and cleaned if necessary.
- 7) Any additional preparation will be noted in the individual test sequences.
- 8) Solder Information: Lead Free
- 9) Samtec Test PCBs used: PCB-106747-TST/PCB-106748-TST/PCB-106749-TST/PCB-106750-TST

FLOWCHARTS

Gas Tight

Group 1 PCIE-064-02-F-D-TH 0.056" EDGE CARD 8 Assemblies

Step Description

- 1. LLCR (2)
- 2. Gas Tight (1)
- LLCR (2) Max Delta = 15 mOhm

(1) Gas Tight = EIA-364-36

(2) LLCR = EIA-364-23

Open Circuit Voltage = 20 mV Max Test Current = 100 mA Max

Normal Force

Group 1 PCIE-064-02-F-D-TH

8 Contacts Minimum Signal Without Thermals

Step Description

- 1. Contact Gaps
- 2. Normal Force (1) Deflection = 0.016 " Expected Force at Max Deflection = 80 g

Group 2 PCIE-064-02-F-D-TH 0.068" EDGE CARD 8 Contacts Minimum

Signal With Thermals

Description Step

- 1. Contact Gaps
- 2. Thermal Age (2)
- 3. Contact Gaps
- Normal Force(1) Expected Force at Max Deflection = 80 g Deflection = 0.016 "

(1) Normal Force = EIA-364-04

(2) Thermal Age = EIA-364-17 Test Condition = 4 (105°C)

Time Condition = B (250 Hours)

Part description: PCIE/CARD

FLOWCHARTS Continued

Thermal Aging

Group 1
PCIE-064-02-F-D-TH
0.056" EDGE CARD
8 Assemblies

Step Description

- 1. Contact Gaps
- 2. Mating/Unmating Force(2)
- 3. LLCR (1)
- Thermal Age (3)
- LLCR (1)
 Max Delta = 15 mOhm
- 6. Mating/Unmating Force(2)
- 7. Contact Gaps

Group 2

PCIE-064-02-F-D-TH 0.068" EDGE CARD 8 Assemblies

Step Description

- Contact Gaps
- 2. Mating/Unmating Force (2)
- 3. LLCR (1)
- Thermal Age (3)
- 5. LLCR (1)
- Max Delta = 15 mOhm
- Mating/Unmating Force (2)
- 7. Contact Gaps

(1) LLCR = EIA-364-23

Open Circuit Voltage = 20 mV Max Test Current = 100 mA Max

- (2) Mating/Unmating Force = EIA-364-13
- (3) Thermal Age = EIA-364-17

Test Condition = 4 (105°C)

Time Condition = B (250 Hours)

Part description: PCIE/CARD

FLOWCHARTS Continued

Mating/Unmating/Durability

Group 1 PCIF-064-02-F-D-TH 0.056" EDGE CARD 8 Assemblies

Step Description

- 1. Contact Gaps
- 2. LLCR (2)
- 3. Mating/Unmating Force(3)
- Quantity = 25 Cycles
- 5. Mating/Unmating Force(3)
- Quantity = 25 Cycles
- 7. Mating/Unmating Force(3)
- 8. Cycles
- Quantity = 25 Cycles
- 9. Mating/Unmating Force(3)
- 10. Cycles Quantity = 25 Cycles
- 11. Mating/Unmating Force(3)
- Contact Gaps 12.
- 13. LLCR (2) Max Delta = 15 mOhm
- 14. Thermal Shock(4)
- Max Delta = 15 mOhm
- Humidity (1)
- 16. LLCR (2)
- Max Delta = 15 mOhm
- Mating/Unmating Force(3)

Group 2 PCIF-164-02-F-D-TH 0.068" EDGE CARD 8 Assemblies

Step Description

- 1. Contact Gaps
- 2. Mating/Unmating Force (3)
- 3. Cycles Quantity = 25 Cycles
- 4. Mating/Unmating Force (3)
- 5. Cycles Quantity = 25 Cycles
- 6. Mating/Unmating Force (3)
- 7. Quantity = 25 Cycles
- 8. Mating/Unmating Force (3)
- 9. Cycles Quantity = 25 Cycles
- Mating/Unmating Force (3)

Group 3 PCIF-036-02-F-D-TH 0.068" EDGE CARD 8 Assemblies

Step Description

- 1. Contact Gaps
- Mating/Unmating Force (3) 2.
- 3. Cycles
- Quantity = 25 Cycles Mating/Unmating Force (3) 4.
- 5. Cycles Quantity = 25 Cycles
- 6. Mating/Unmating Force (3)
- 7. Quantity = 25 Cycles
- 8. Mating/Unmating Force (3)
- 9. Cycles Quantity = 25 Cycles
- Mating/Unmating Force (3)

Group 4 PCIF-064-02-F-D-TH

0.068" EDGE CARD 8 Assemblies

Step Description

- 1. Contact Gaps
- 2. LLCR (2)
- Mating/Unmating Force (3) 3.
- Cycles Quantity = 25 Cycles
- 5. Mating/Unmating Force (3)
- Cycles
- Quantity = 25 Cycles 7. Mating/Unmating Force (3)
- 8. Cycles
- Quantity = 25 Cycles
- 9. Mating/Unmating Force (3)
- 10. Cycles
- Quantity = 25 Cycles 11. Mating/Unmating Force (3)
- Contact Gaps 12.
- 13. LLCR (2)
- Max Delta = 15 mOhm
- 14. Thermal Shock (4)
- LLCR (2)
- Max Delta = 15 mOhm 16. Humidity (1)
- 17. LLCR (2)
- Max Delta = 15 mOhm
- 18. Mating/Unmating Force (3)

(1) Humidity = EIA-364-31

Test Condition = B (240 Hours)

Test Method = III (+25oC to +65tC @ 90% RH to 98% RH)

Test Exceptions: ambient pre-condition and delete steps 7a and 7b

(2) LLCR = EIA-364-23

Open Circuit Voltage = 20 mV Max

Test Current = 100 mA Max

(3) Mating/Unmating Force = EIA-364-13

(4) Thermal Shock = EIA-364-32 Exposure Time at Temperature Extremes = 1/2 Hour Method A, Test Condition = I (-55oC to +85tC)

Test Duration = A-3 (100 Cycles)

Tracking Code: 478081 Report Rev 1

Part description: PCIE/CARD

FLOWCHARTS Continued

IR/DWV

<u>Pin-to-Pin</u>

Group 1
PCIE-064-02-F-D-TH
0.056" EDGE CARD
2 Assemblies

Step Description

DWV Breakdown (2)

Group 2 PCIE-064-02-F-D-TH

2 Assemblies

Group 3
PCIE-064-02-F-D-TH
0.056" EDGE CARD
2 Assemblies

Step Description

DWV Breakdown₍₂₎

Step Description

- 1. IR (4)
- 2. DWV at Test Voltage(1)
- 3. Thermal Shock (5)
- 4. IR (4
- 5. DWV at Test Voltage(1)
- 6. Humidity (3)
- 7. IR (4)
- 8. DWV at Test Voltage(1)

Row-to-Row

Group 4
PCIE-064-02-F-D-TH
0.056" EDGE CARD
2 Assemblies

Group 5 PCIE-064-02-F-D-TH

2 Assemblies

Group 6
PCIE-064-02-F-D-TH
0.056" EDGE CARD
2 Assemblies

Step Description

1. DWV Breakdown (2)

Step Description

DWV Breakdown₍₂₎

Step Description

- 1. IR (4)
- 2. DWV at Test Voltage(1)
- 3. Thermal Shock (5)
- 4. IR (4)
- 5. DWV at Test Voltage(1)
- 6. Humidity (3)
- 7. IR (4
- DWV at Test Voltage(1)

(1) DWV at Test Voltage = EIA-364-20

Test Condition = 1 (Sea Level)

DWV test voltage is equal to 75% of the lowest breakdown voltage Test voltage applied for 60 seconds

(2) DWV Breakdown = EIA-364-20

Test Condition = 1 (Sea Level)

DWV test voltage is equal to 75% of the lowest breakdown voltage Test voltage applied for 60 seconds

(3) Humidity = EIA-364-31

Test Condition = B (240 Hours)

Test Method = III (+25°C to +65°C @ 90% RH to 98% RH)

Test Exceptions: ambient pre-condition and delete steps 7a and 7b

(4) IR = EIA-364-21

Test Condition = 500 Vdc, 2 Minutes Max

(5) Thermal Shock = EIA-364-32

Exposure Time at Temperature Extremes = 1/2 Hour Method A, Test Condition = I (-55°C to +85°C)

Test Duration = A-3 (100 Cycles)

Tracking Code: 478081_Report_Rev_1 Part #: PCIE-064-02-F-D-TH/EDGE CARD Part description: PCIE/CARD

FLOWCHARTS Continued

Current Carrying Capacity

Group 1 PCIE-164-02-F-D-TH 0.056" EDGE CARD 2 Pins Powered Signal

Step Description CCC(1) 1. Rows=2 Number of Positions = 1

Group 2 PCIE-164-02-F-D-TH 0.056" EDGE CARD 4 Pins Powered Signal

Step Description 1. CCC (1) Number of Positions = 2

Group 3 PCIE-164-02-F-D-TH 0.056" EDGE CARD 6 Pins Powered Signal

Description Step 1. CCC (1) Number of Positions = 3

Group 4 PCIE-164-02-F-D-TH 0.056" EDGE CARD 8 Pins Powered Signal

Description Step CCC (1) 1. Number of Positions = 4

PCIE-164-02-F-D-TH 0.056" EDGE CARD 164 Pins Powered Signal

Step Description

CCC₍₁₎ Rows=2 1. Number of Positions = 82

(1) CCC = EIA-364-70

Method 2, Temperature Rise Versus Current Curve (TIN PLATING) - Tabulate calculated current at RT, 65°C, 75°C and 95°C after derating 20% and based on 105°C (GOLD PLATING) - Tabulate calculated current at RT, 85°C, 95°C and 115°C after derating 20% and based on 125°C

Part description: PCIE/CARD

FLOWCHARTS Continued

Mechanical Shock/Random Vibration/LLCR

Group 1
PCIE-064-02-F-D-TH
0.056" EDGE CARD
8 Assemblies

Group 2

PCIE-064-02-F-D-TH 0.068" EDGE CARD 8 Assemblies

Step Description

- 1. LLCR (1)
- 2. Mechanical Shock (2)
- 3. Random Vibration (3)
- LLCR (1) Max Delta = 15 mOhm
- Step Description
- 1. LLCR (1)
- 2. Mechanical Shock (2)
- Random Vibration (3)
- 4. LLCR (1)

Max Delta = 15 mOhm

(1) LLCR = EIA-364-23

Open Circuit Voltage = 20 mV Max Test Current = 100 mA Max

(2) Mechanical Shock = EIA-364-27

Test Condition = C (100 G Peak, 6 milliseconds, Half Sine) Number of Shocks = 3 Per Direction, Per Axis, 18 Total

(3) Random Vibration = EIA-364-28

Condition = VB (7.56 gRMS Average, 2 Hours/Axis)

Mechanical Shock/Random Vibration/Event Detection

Group 1
PCIE-064-02-F-D-TH
0.056" EDGE CARD
60 Points

Step Description

- Nanosecond Event Detection (Mechanical Shock) (1)
- Nanosecond Event Detection (Random Vibration)₍₂₎

(1) Nanosecond Event Detection (Mechanical Shock)

Use EIA-364-87 for Nanosecond Event Detection:

Test Condition = F (50 nanoseconds at 10 ohms)

Use EIA-364-27 for Mechanical Shock:

Test Condition = C (100 G Peak, 6 milliseconds, Half Sine) Number of Shocks = 3 Per Direction, Per Axis, 18 Total

(2) Nanosecond Event Detection (Random Vibration)

Use EIA-364-87 for Nanosecond Event Detection:

Test Condition = F (50 nanoseconds at 10 ohms)

Use EIA-364-28 for Random Vibration:

Condition = VB (7.56 gRMS Average, 2 Hours/Axis)

ATTRIBUTE DEFINITIONS

The following is a brief, simplified description of attributes.

THERMAL SHOCK:

- 1) EIA-364-32, Thermal Shock (Temperature Cycling) Test Procedure for Electrical Connectors.
- 2) Test Condition 1: -55°C to +85°C
- 3) Test Time: ½ hour dwell at each temperature extreme
- 4) Number of Cycles: 100
- 5) All test samples are pre-conditioned at ambient.
- 6) All test samples are exposed to environmental stressing in the mated condition.

THERMAL:

- 1) EIA-364-17, Temperature Life with or without Electrical Load Test Procedure for Electrical Connectors.
- 2) Test Condition 4 at 105° C
- 3) Test Time Condition B for 250 hours.
- 4) All test samples are pre-conditioned at ambient.
- 5) All test samples are exposed to environmental stressing in the mated condition.

HUMIDITY:

- 1) Reference document: EIA-364-31, Humidity Test Procedure for Electrical Connectors.
- 2) Test Condition B, 240 Hours.
- 3) Method III, +25° C to +65° C, 90% to 98% Relative Humidity excluding sub-cycles 7a and 7b.
- 4) All samples are pre-conditioned at ambient.
- 5) All test samples are exposed to environmental stressing in the mated condition.

MECHANICAL SHOCK (Specified Pulse):

- 1) Reference document: EIA-364-27, Mechanical Shock Test Procedure for Electrical Connectors
- 2) Test Condition C
- 3) Peak Value: 100 G
- 4) Duration: 6 Milliseconds
- 5) Wave Form: Half Sine
- 6) Velocity: 12.3 ft/s
- 7) Number of Shocks: 3 Shocks / Direction, 3 Axis (18 Total)

VIBRATION:

- 1) Reference document: EIA-364-28, Vibration Test Procedure for Electrical Connectors
- 2) Test Condition V, Letter B
- 3) Power Spectral Density: 0.04 G² / Hz
- 4) G 'RMS': 7.56
- 5) Frequency: 50 to 2000 Hz
- 6) Duration: 2.0 Hours per axis (3 axis total)

NANOSECOND-EVENT DETECTION:

- 1) Reference document: EIA-364-87, Nanosecond-Event Detection for Electrical Connectors
- 2) Prior to test, the samples were characterized to assure the low nanosecond event being monitored will trigger the detector.
- 3) After characterization it was determined the test samples could be monitored for 50 nanosecond events

MATING/UNMATING:

- 1) Reference document: EIA-364-13, Mating and Unmating Forces Test Procedure for Electrical Connectors.
- 2) The full insertion position was to within 0.003" to 0.004" of the plug bottoming out in the receptacle to prevent damage to the system under test.
- 3) One of the mating parts is secured to a floating X-Y table to prevent damage during cycling.

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD	
Part description: PCIE/CARD		

The following is a brief, simplified description of attributes.

TEMPERATURE RISE (Current Carrying Capacity, CCC):

- 1) EIA-364-70, Temperature Rise versus Current Test Procedure for Electrical Connectors and Sockets.
- 2) When current passes through a contact, the temperature of the contact increases as a result of I^2R (resistive) heating.
- 3) The number of contacts being investigated plays a significant part in power dissipation and therefore temperature rise.
- 4) The size of the temperature probe can affect the measured temperature.
- 5) Copper traces on PC boards will contribute to temperature rise:
 - a. Self heating (resistive)
 - b. Reduction in heat sink capacity affecting the heated contacts
- 6) A de-rating curve, usually 20%, is calculated.
- 7) Calculated de-rated currents at four temperature points are reported:
 - a. Ambient
 - b 85° C
 - c. 95° C
 - d. 115° C
- 8) Typically, neighboring contacts (in close proximity to maximize heat build up) are energized.
- 9) The thermocouple (or temperature measuring probe) will be positioned at a location to sense the maximum temperature in the vicinity of the heat generation area.
- 10) A computer program, TR 803.exe, ensures accurate stability for data acquisition.
- 11) Hook-up wire cross section is larger than the cross section of any connector leads/PC board traces, jumpers, etc.
- 12) Hook-up wire length is longer than the minimum specified in the referencing standard.

LLCR:

- 1) EIA-364-23, Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets.
- 2) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 3) The following guidelines are used to categorize the changes in LLCR as a result from stressing
 - a. <= +5.0 mOhms: ----- Stable
 - b. +5.1 to +10.0 mOhms:----- Minor
 - c. +10.1 to +15.0 mOhms: ----- Acceptable
 - d. +15.1 to +50.0 mOhms: ----- Marginal
 - e. +50.1 to +2000 mOhms: ----- Unstable
 - f. >+2000 mOhms:----- Open Failure

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD	
Part description: PCIE/CARD		

The following is a brief, simplified description of attributes.

GAS TIGHT:

To provide method for evaluating the ability of the contacting surfaces in preventing penetration of harsh vapors which might lead to oxide formation that may degrade the electrical performance of the contact system.

- 1) EIA-364-23, Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets.
- 2) A computer program, LLCR 221.exe, ensures repeatability for data acquisition.
- 3) The following guidelines are used to categorize the changes in LLCR as a result from stressing
 - a. <= +5.0 mOhms: ----- Stable
 - b. +5.1 to +10.0 mOhms:----- Minor
 - c. +10.1 to +15.0 mOhms: ----- Acceptable
 - d. +15.1 to +50.0 mOhms: ----- Marginal
 - e. +50.1 to +2000 mOhms: ----- Unstable
 - f. >+2000 mOhms:----- Open Failure
- 4) Procedure:
 - a. Reference document: EIA-364-36, *Test Procedure for Determination of Gas-Tight Characteristics for Electrical Connectors, Sockets and/or Contact Systems*.
 - b. Test Conditions:
 - i. Class II--- Mated pairs of contacts assembled to their plastic housings.
 - ii. Reagent grade Nitric Acid shall be used of sufficient volume to saturate the test chamber
 - iii. The ratio of the volume of the test chamber to the surface area of the acid shall be 10:1.
 - iv. The chamber shall be saturated with the vapor for at least 15 minutes before samples are added.
 - v. Exposure time, 55 to 65 minutes.
 - vi. The samples shall be no closer to the chamber walls than 1 inches and no closer to the surface of the acid than 3 inches.
 - vii. The samples shall be dried after exposure for a minimum of 1 hour.
 - viii. Drying temperature 50° C
 - ix. The final LLCR shall be conducted within 1 hour after drying.

Tracking Code: 478081 Report Rev 1	Part #: PCIE-064-02-F-D-TH/EDGE CARD	
Part description: PCIF/CARD		

The following is a brief, simplified description of attributes

NORMAL FORCE (FOR CONTACTS TESTED IN THE HOUSING):

- 1) Reference document: EIA-364-04, Normal Force Test Procedure for Electrical Connectors.
- 2) The contacts shall be tested in the connector housing.
- 3) If necessary, a "window" shall be made in the connector body to allow a probe to engage and deflect the contact at the same attitude and distance (plus 0.05 mm [0.002"]) as would occur in actual use.
- 4) The connector housing shall be placed in a holding fixture that does not interfere with or otherwise influence the contact force or deflection.
- 5) Said holding fixture shall be mounted on a floating, adjustable, X-Y table on the base of the Dillon TC², computer controlled test stand with a deflection measurement system accuracy of 5.0 μm (0.0002").
- 6) The nominal deflection rate shall be 5 mm (0.2")/minute.
- 7) Unless otherwise noted a minimum of five contacts shall be tested.
- 8) The force/deflection characteristic to load and unload each contact shall be repeated five times.
- 9) The system shall utilize the TC² software in order to acquire and record the test data.
- 10) The permanent set of each contact shall be measured within the TC² software.
- 11) The acquired data shall be graphed with the deflection data on the X-axis and the force data on the Y-axis and a print out will be stored with the Tracking Code paperwork.

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD	
Part description: PCIE/CARD		

The following is a brief, simplified description of attributes

INSULATION RESISTANCE (IR):

To determine the resistance of insulation materials to leakage of current through or on the surface of these materials when a DC potential is applied.

- 1) PROCEDURE:
 - a. Reference document: EIA-364-21, Insulation Resistance Test Procedure for Electrical Connectors.
 - b. Test Conditions:
 - i. Between Adjacent Contacts or Signal-to-Ground
 - ii. Electrification Time 2.0 minutes
 - iii. Test Voltage (500 VDC) corresponds to calibration settings for measuring resistances.
- 2) MEASUREMENTS:
- 3) When the specified test voltage is applied (VDC), the insulation resistance shall not be less than 5000 megohms.

DIELECTRIC WITHSTANDING VOLTAGE (DWV):

To determine if the sockets can operate at its rated voltage and withstand momentary over potentials due to switching, surges, and other similar phenomenon. Separate samples are used to evaluate the effect of environmental stresses so not to influence the readings from arcing that occurs during the measurement process.

- 1) PROCEDURE:
 - a. Reference document: EIA-364-20, Withstanding Voltage Test Procedure for Electrical Connectors.
 - b. Test Conditions:
 - i. Between Adjacent Contacts or Signal-to-Ground
 - ii. Barometric Test Condition 1
 - iii. Rate of Application 500 V/Sec
 - iv. Test Voltage (VAC) until breakdown occurs
- 2) MEASUREMENTS/CALCULATIONS
 - a. The breakdown voltage shall be measured and recorded.
 - b. The dielectric withstanding voltage shall be recorded as 75% of the minimum breakdown voltage.
 - c. The working voltage shall be recorded as one-third (1/3) of the dielectric withstanding voltage (one-fourth of the breakdown voltage).

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD	
Part description: PCIE/CARD		

	RESULTS
Temperature Rise, CCC at a 20%	de-rating
<u> </u>	Rise2.4 A per contact with 2 contacts (2 x 1) powered
	Rise2.0 A per contact with 4 contacts (2 x 2) powered
-	Rise1.7 A per contact with 6 contacts (2 x 3) powered
	Rise1.6 A per contact with 8 contacts (2 x 4) powered
	Rise0.8 A per contact with 164 contacts (2 x 82) powered
Mating/Unmating Forces	
Thermal Aging Group	
PCIE-064-02-F-D-TH/EDGE CARD	0.056"
• Initial	
o Mating	
	3.14 Lbs
Max	4.35 Lbs
 Unmating 	
	1.46 Lbs
	2.02 Lbs
 After Thermal 	
Mating	
11211	2.49 Lbs
	3.31 Lbs
o Unmating	14011
	1.28 Lbs 1.96 Lbs
- Wax	1,90 LDS
PCIE-064-02-F-D-TH /EDGE CARI	0.068"
• Initial	
o Mating	400 7.1
	4.09 Lbs
	5.22 Lbs
○ Unmating ■ Min	1.76 Lbs
After Thermal	2.10 Lbs
After Thermal Mating	
	3.07 Lbs
	3.53 Lbs
 Unmating 	
• M:	150 I ka

Max-----

------1.50 Lbs ------ 1.77 Lbs

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD	
Part description: PCIE/CARD		

Mating/Unmating Forces Mating-Unmating Durability Group (PCIE-064-02-F-D-TH /EDGE CARD 0.056") Initial **Mating** Min ----- 3.50 Lbs Max----- 4.44 Lbs Unmating Min ----- 1.60 Lbs Max----- 2.07 Lbs **After 25 Cycles** Mating Min ----- 4.15 Lbs Max----- 5.44 Lbs Unmating Min ----- 1.98 Lbs Max----- 2.55 Lbs After 50 Cycles Mating Max----- 5.78 Lbs Unmating Min ----- 2.18 Lbs Max----- 2.79 Lbs **After 75 Cycles** Mating Min ----- 4.40 Lbs Max----- 5.95 Lbs

Humidity

After 100 Cycles Mating

> Mating 0

Unmating

Unmating

Min ----- 2.21 Lbs Max----- 3.03 Lbs

Max-----2.91 Lbs

Max----- 6.05 Lbs

Max----- 3.01 Lbs

- Unmating
 - Min ----- 1,28 Lbs
 - Max----- 1.58 Lbs

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD	
Part description: PCIE/CARD		

Mating/Unmating Forces Mating-Unmating Durability Group (PCIE-064-02-F-D-TH /EDGE CARD 0.068") Initial **Mating** Min ----- 3.38 Lbs Max----- 4.71 Lbs Unmating Min ----- 1.54 Lbs Max----- 2.06 Lbs **After 25 Cycles** Mating Min ----- 4.00 Lbs Max----- 5.94 Lbs Unmating Min ------ 1.95 Lbs Max----- 2.59 Lbs After 50 Cycles Mating Max----- 6.22 Lbs Unmating Min ----- 2.29 Lbs Max-----2.81 Lbs **After 75 Cycles** Mating Min ----- 4.29 Lbs Max----- 6.69 Lbs Unmating Max----- 3.14 Lbs **After 100 Cycles** Mating

Unmating

Mating

Unmating

Humidity

0

Max------ 6.94 Lbs

Max----- 3.29 Lbs

Min ----- 1.92 Lbs Max----- 3.43 Lbs

Min ----- 0.97 Lbs Max----- 1.60 Lbs

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD
Part description	on: PCIE/CARD

Mating/Unmating Forces

Mating-Unmating Basic Group (PCIE-164-02-F-D-TH /EDGE CARD 0.068")

- Initial
 - **Mating**
 - Min ----- 7.93 Lbs
 - Max-----9.68 Lbs
 - Unmating
 - Min ----- 3.19 Lbs
 - Max----- 3.72 Lbs
- **After 25 Cycles**
 - Mating
 - Min ----- 8.96 Lbs
 - Max-----12.33 Lbs
 - Unmating
 - Min ----- 3.51 Lbs
- Max----- 5.73 Lbs
- After 50 Cycles
 - Mating
 - - Max-----13.75 Lbs
 - Unmating
 - Min ----- 4.60 Lbs
 - Max----- 6.44 Lbs
- **After 75 Cycles**
 - Mating
 - Min ------10.50 Lbs
 - Max-----14.68 Lbs
 - Unmating
 - Min ----- 5.14 Lbs
 - Max----- 7.04 Lbs
- **After 100 Cycles**
 - Mating
 - Min -----11.24 Lbs
 - Max------15.18 Lbs
 - Unmating

 - Max----- 7.44 Lbs

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD
Part description	on: PCIE/CARD

RESULTS Continued Mating/Unmating Forces Mating-Unmating Basic Group (PCIE-036-02-F-D-TH/EDGE CARD 0.068") Initial **Mating** Min ----- 1.62 Lbs Max----- 2.08 Lbs Unmating Min ----- 0.45 Lbs Max----- 0.79 Lbs **After 25 Cycles** Mating Min ----- 1.55 Lbs Max-----2.34 Lbs Unmating Min ----- 0.65 Lbs Max----- 1.13 Lbs After 50 Cycles Mating Max-----2.49 Lbs Unmating Min ----- 0.70 Lbs Max-----1.35 Lbs **After 75 Cycles** Mating Min ----- 1.52 Lbs Max-----2.64 Lbs Unmating Min ----- 0.75 Lbs Max----- 1.48 Lbs **After 100 Cycles** Mating Min ----- 1.56 Lbs Max------ 2.24 Lbs Unmating Max----- 1.57 Lbs Normal Force at 0.0132 inches deflection Initial Set ---- 0.0000 in 0 Max ------64.70 gf Set ---- 0.0003 in 0 **Thermal** Min-----39.00 gf Set ---- 0.0004 in

Max -----48.10 gf

0

Set ---- 0.0024 in

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD
Part descripti	on: PCIE/CARD

RESULTS Continued Insulation Resistance minimums, IR Pin to Pin • Initial 0 Thermal Shock Humidity Mated------ Passed Unmated ----- 7863 Meg Ω ----- Passed Row to Row Initial Thermal Shock Mated ------ Passed Unmated ------ 10000 Meg Ω ------ Passed Unmated ------o Mated---0 Humidity \circ Unmated ------ Passed Dielectric Withstanding Voltage minimums, DWV **Minimums** Breakdown Voltage ------875 VAC Test Voltage ------660 VAC Working Voltage ----- 215 VAC Pin to Pin Initial DWV ------Passed Thermal DWV------Passed Humidity DWV------Passed Row to Row Initial DWV ------Passed Thermal DWV------Passed

Humidity DWV------Passed

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD					
Part description: PCIE/CARD						

LLCR Thermal Aging Group (192 LLCR test points) PCIE-064-02-F-D-TH /EDGE CARD 0.056" ----- 11.87 mOhms Max Initial -----**Thermal** <= +5.0 mOhms ------ Stable +5.1 to +10.0 mOhms ----- Minor +10.1 to +15.0 mOhms ------ Acceptable +15.1 to +50.0 mOhms ------ Marginal +50.1 to +2000 mOhms------ Unstable >+2000 mOhms------Open Failure PCIE-064-02-F-D-TH /EDGE CARD 0.068" Initial ----- 10.83 mOhms Max Thermal o <= +5.0 mOhms ----- Stable +50.1 to +2000 mOhms------- Unstable \circ >+2000 mOhms------ Open Failure LLCR Gas Tight Group (192 LLCR test points) PCIE-064-02-F-D-TH /EDGE CARD 0.056" ----- 11.96 mOhms Max Initial ---Gas-Tight <= +5.0 mOhms ------ Stable +5.1 to +10.0 mOhms ------ Minor +10.1 to +15.0 mOhms ------ Acceptable +15.1 to +50.0 mOhms ------ Marginal +50.1 to +2000 mOhms------- Unstable >+2000 mOhms------ Open Failure

Part description: PCIE/CARD

RESULTS Continued

LLCR Mating/Unmating Durability Group (192 LLCR test points)
PCIE-064-02-F-D-TH /EDGE CARD 0.056"

Г		UZ-F-D-TH /EDGE CARD U.USU		
•	Initial		11.56 mOhms Max	
•	Durab	ility, 100 Cycles		
	0	<= +5.0 mOhms	192 Points	Stable
	0	+5.1 to +10.0 mOhms	0 Points	Minor
	0	+10.1 to +15.0 mOhms		
	0	+15.1 to +50.0 mOhms		
	0	+50.1 to +2000 mOhms		0
	0	>+2000 mOhms		
	_	aal Shock	o i ones	open i anuic
•	0	<= +5.0 mOhms	102 Points	Stabla
	-	+5.1 to +10.0 mOhms		
	0	+10.1 to +15.0 mOhms		
	0	+10.1 to +15.0 mOhms+ +15.1 to +50.0 mOhms		
	0			
	0	+50.1 to +2000 mOhms		
	0	>+2000 mOhms	Points	Open Failure
•	Humid	•		
	0	<= +5.0 mOhms		
	0	+5.1 to +10.0 mOhms		
	0	+10.1 to +15.0 mOhms		
	0	+15.1 to +50.0 mOhms		
	0	+50.1 to +2000 mOhms	0 Points	Unstable
	0	>+2000 mOhms	0 Points	Open Failure
DC	TE 0/4 (M E D TH /EDGE CADD A ACOII		
PC		02-F-D-TH /EDGE CARD 0.068"		
•			11.35 mOhms Max	
•	Durab	ility, 100 Cycles		
	0	<= +5.0 mOhms		
	0	+5.1 to +10.0 mOhms		
	0	+10.1 to +15.0 mOhms		
	0	+15.1 to +50.0 mOhms		
	0	+50.1 to +2000 mOhms		
	0	>+2000 mOhms	0 Points	Open Failure
•	Therm	nal Shock		
	0	<= +5.0 mOhms	192 Points	Stable
	0	+5.1 to +10.0 mOhms		
	0	+10.1 to +15.0 mOhms		
	0	+15.1 to +50.0 mOhms		
	0	+50.1 to +2000 mOhms		
	0	>+2000 mOhms		
			or omes	Open Fanure
•	Humid		101 Daints	Stable
	0			
	0	+5.1 to +10.0 mOhms		
	0	+10.1 to +15.0 mOhms		
	0	+15.1 to +50.0 mOhms		8
	0	+50.1 to +2000 mOhms		
	0	>+2000 mOhms		Open Failure

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD					
Part description: PCIE/CARD						

RESULTS Continued LLCR Shock & Vibration Group (192 LLCR test points) PCIE-064-02-F-D-TH /EDGE CARD 0.056" ------ 11.27 mOhms Max Initial ----**Shock & Vibration** <= +5.0 mOhms ------ Stable +5.1 to +10.0 mOhms------ Minor +10.1 to +15.0 mOhms ------ Acceptable +15.1 to +50.0 mOhms ------ Marginal +50.1 to +2000 mOhms------ Unstable >+2000 mOhms------ Open Failure **Mechanical Shock & Random Vibration:** o Shock No Damage------Pass 50 Nanoseconds------Pass Vibration No Damage------Pass 50 Nanoseconds------ Pass PCIE-064-02-F-D-TH /EDGE CARD 0.068" Initial ----- 10.70 mOhms Max **Shock & Vibration** o <= +5.0 mOhms ------ Stable +5.1 to +10.0 mOhms ------ Minor +10.1 to +15.0 mOhms ------ Acceptable +15.1 to +50.0 mOhms ------ Marginal 0 +50.1 to +2000 mOhms------ Unstable 0 >+2000 mOhms------O Points------Open Failure

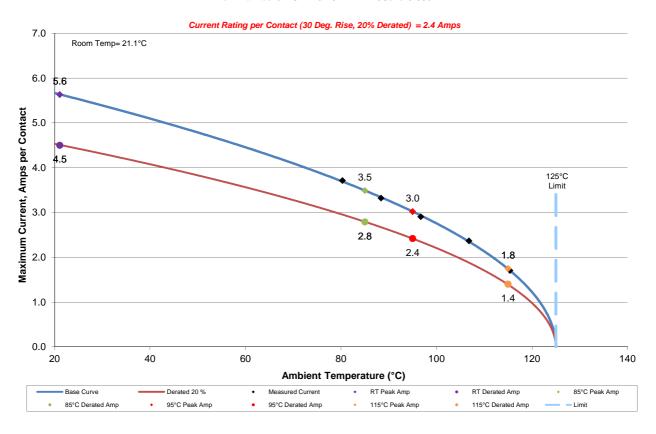
Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD					
Part description: PCIE/CARD						

DATA SUMMARIES

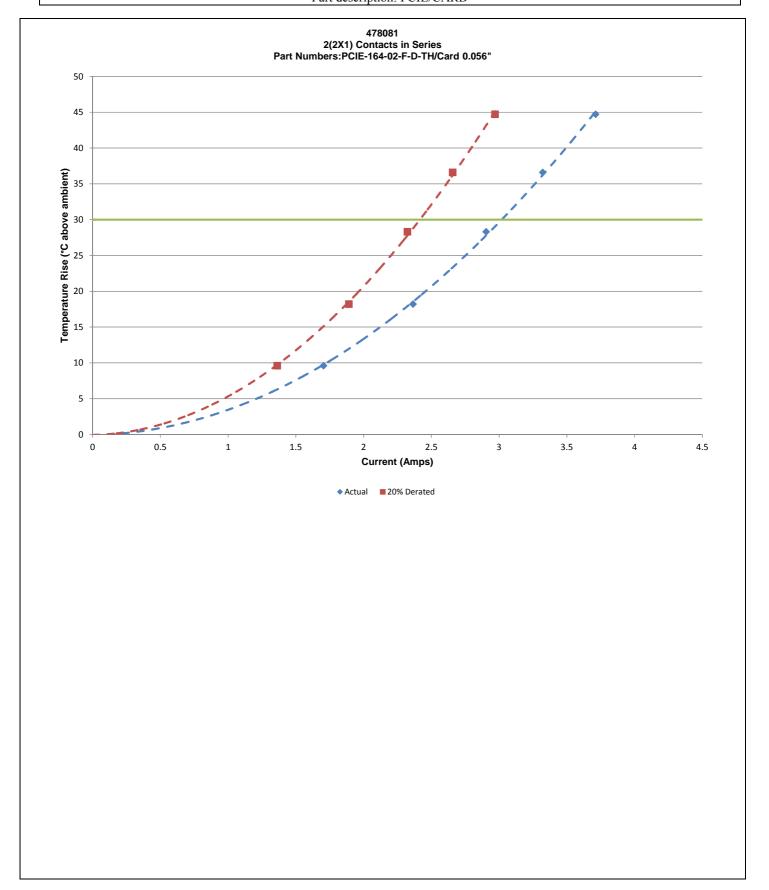
TEMPERATURE RISE (Current Carrying Capacity, CCC):

- 1) High quality thermocouples whose temperature slopes track one another were used for temperature monitoring.
- 2) The thermocouples were placed at a location to sense the maximum temperature generated during testing.
- 3) Temperature readings recorded are those for which three successive readings, 15 minutes apart, differ less than 1° C (computer controlled data acquisition).
- 4) Adjacent contacts were powered:
 - a. Linear configuration with 2 adjacent conductors/contacts powered

478081 2(2X1) Contacts in Series Part Numbers:PCIE-164-02-F-D-TH/Card 0.056"



Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD					
Part description: PCIE/CARD						



DATA SUMMARIES Continued b. Linear configuration with 4 adjacent conductors/contacts powered 478081 4(2X2) Contacts in Series Part Numbers:PCIE-164-02-F-D-TH/Card 0.056" Current Rating per Contact (30 Deg. Rise, 20% Derated) = 2.0 Amps 6.0 Room Temp= 22.0°C 5.0 3.8 2.9 2.5 2.0 1.0 0.0 60 100 20 40 80 120 140 Ambient Temperature (°C) Base Curve RT Peak Amp RT Derated Amp 85°C Peak Amp Derated 20 % red Current 95°C Peak Amp 95°C Derated Amp 115°C Peak Amp 115°C Derated Amp 4(2X2) Contacts in Series Part Numbers:PCIE-164-02-F-D-TH/Card 0.056" 45 40 35 Temperature Rise (°C above ambient) 10 5

Page 26 of 46

Current (Amps)

◆ Actual ■ 20% Derated

2.5

3

3.5

0

0.5

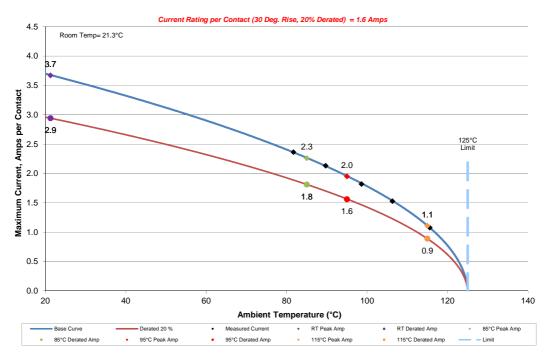
Part description: PCIE/CARD **DATA SUMMARIES Continued** c. Linear configuration with 6 adjacent conductors/contacts powered 478081 6(2X3) Contacts in Series Part Numbers:PCIE-164-02-F-D-TH/Card 0.056" Current Rating per Contact (30 Deg. Rise, 20% Derated) = 1.7 Amps 5.0 Room Temp= 21.1°C 4.5 4.0 Maximum Current, Amps per Contact 3.5 2.5 2.0 1.5 1.0 125°C Limit 2.1 2.0 1.2 0.5 0.0 20 40 60 80 120 140 Ambient Temperature (°C) 85°C Peak Amp Base Curve Measured Current RT Peak Amp RT Derated Amp - Derated 20 % 95°C Peak Amp 115°C Peak Amp 115°C Derated Amp 85°C Derated Amp 95°C Derated Amp 478081 6(2X3) Contacts in Series Part Numbers:PCIE-164-02-F-D-TH/Card 0.056" 40 35 Temperature Rise (°C above ambient) 20 12 12 10 5 0 0.5 1.5 2.5 Current (Amps)

Page 27 of 46

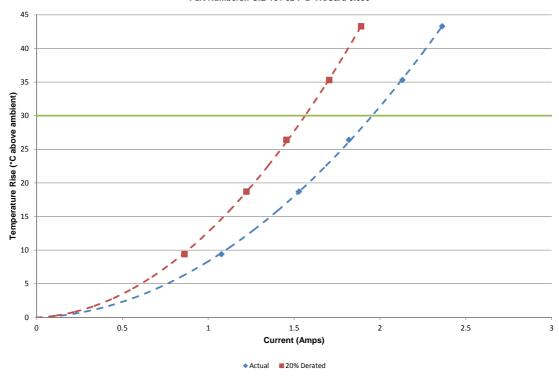
◆ Actual ■ 20% Derated

d. Linear configuration with 8 adjacent conductors/contacts powered

478081 8(2X4) Contacts in Series Part Numbers:PCIE-164-02-F-D-TH/Card 0.056"

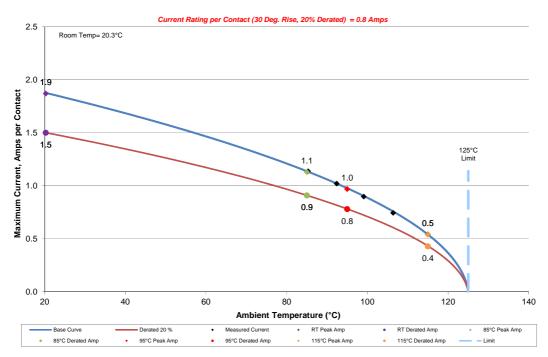


478081 8(2X4) Contacts in Series Part Numbers:PCIE-164-02-F-D-TH/Card 0.056"

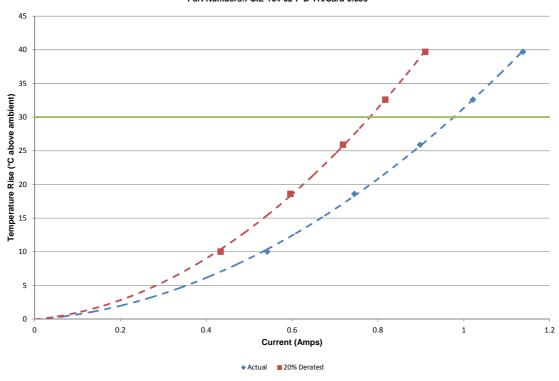


e. Linear configuration with all adjacent conductors/contacts powered

478081 164(2X82) Contacts in Series Part Numbers:PCIE-164-02-F-D-TH/Card 0.056"



478081 164(2X82) Contacts in Series Part Numbers:PCIE-164-02-F-D-TH/Card 0.056"



Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD				
Part description: PCIE/CARD					

MATING-UNMATING FORCE:

Thermal Aging Group

PCIE-064-02-F-D-TH /EDGE CARD 0.056"

	Initial			After Thermals				
	Mating Unmating		Mating		Unmating			
	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)
Minimum	13.97	3.14	6.49	1.46	11.08	2.49	5.69	1.28
Maximum	19.35	4.35	8.98	2.02	14.72	3.31	8.72	1.96
Average	16.01	3.60	8.17	1.84	12.64	2.84	7.78	1.75
St Dev	1.73	0.39	0.87	0.20	1.14	0.26	1.05	0.24
Count	8	8	8	8	8	8	8	8

PCIE-064-02-F-D-TH /EDGE CARD 0.068"

	Initial			After Thermals				
	Mating Unmating		Mating		Unmating			
	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)
Minimum	18.19	4.09	7.83	1.76	13.66	3.07	6.67	1.50
Maximum	23.22	5.22	9.70	2.18	15.70	3.53	7.87	1.77
Average	19.78	4.45	8.41	1.89	15.02	3.38	7.43	1.67
St Dev	1.62	0.36	0.61	0.14	0.64	0.14	0.39	0.09
Count	8	8	8	8	8	8	8	8

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD			
Part description: PCIE/CARD				

MATING-UNMATING FORCE:

		NG FORCE: urability Group		4-02-F-D-TH /I	EDGE CAR	D 0.056")		
		Ini	tial		After 25 Cycles			
	М	ating	Uni	mating	М	ating	Uni	mating
	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)
Minimum	15.57	3.50	7.12	1.60	18.46	4.15	8.81	1.98
Maximum	19.75	4.44	9.21	2.07	24.20	5.44	11.34	2.55
Average	17.69	3.98	8.12	1.83	21.22	4.77	9.75	2.19
St Dev	1.54	0.35	0.71	0.16	2.34	0.53	1.03	0.23
Count	8	8	8	8	8	8	8	8
	After 50 Cycles				After 75 Cycles			
	М	ating	Uni	mating	М	ating	Uni	mating
	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)
Minimum	19.13	4.30	9.70	2.18	19.57	4.40	10.32	2.32
Maximum	25.71	5.78	12.41	2.79	26.47	5.95	12.94	2.91
Average	22.32	5.02	10.79	2.43	23.22	5.22	11.45	2.57
St Dev	2.64	0.59	0.98	0.22	2.72	0.61	0.95	0.21
Count	8	8	8	8	8	8	8	8
		After 10	0 Cycles		After Humidity			
	М	ating	Uni	mating	М	ating	Uni	mating
	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)
Minimum	20.15	4.53	10.81	2.43	9.83	2.21	5.69	1.28
Maximum	26.91	6.05	13.39	3.01	13.48	3.03	7.03	1.58
Average	24.00	5.40	12.34	2.77	12.04	2.71	6.38	1.44
St Dev	2.69	0.60	0.93	0.21	1.23	0.28	0.46	0.10
Count	8	8	8	8	8	8	8	8

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD				
Part description: PCIE/CARD					

MATING-UNMATING FORCE:

	Mating-Unimating Durability Group (PCIE-064-02-F-D-TH /EDGE CARD 0.068")							
		Ini	tial		After 25 Cycles			
	М	ating	Uni	mating	M	ating	Uni	mating
	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)
Minimum	15.03	3.38	6.85	1.54	17.79	4.00	8.67	1.95
Maximum	20.95	4.71	9.16	2.06	26.42	5.94	11.52	2.59
Average	19.45	4.37	7.81	1.76	23.15	5.20	10.10	2.27
St Dev	1.88	0.42	0.81	0.18	2.44	0.55	1.02	0.23
Count	8	8	8	8	8	8	8	8
	After 50 Cycles					After 75	Cycles	
	М	ating	Uni	mating	М	ating	Uni	mating
	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)
Minimum	18.46	4.15	10.19	2.29	19.08	4.29	11.12	2.50
Maximum	27.67	6.22	12.50	2.81	29.76	6.69	13.97	3.14
Average	24.11	5.42	11.23	2.53	24.82	5.58	12.10	2.72
St Dev	2.60	0.58	0.79	0.18	2.98	0.67	0.93	0.21
Count	8	8	8	8	8	8	8	8
		After 10	0 Cycles		After Humidity			
	М	ating	Uni	mating	М	ating	Uni	mating
	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)
Minimum	19.88	4.47	11.48	2.58	8.54	1.92	4.31	0.97
Maximum	30.87	6.94	14.63	3.29	15.26	3.43	7.12	1.60
Average	25.54	5.74	12.63	2.84	12.81	2.88	5.59	1.26
St Dev	2.99	0.67	0.96	0.22	2.18	0.49	0.97	0.22
Count	8	8	8	8	8	8	8	8

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD			
Part description: PCIE/CARD				

MATING-UNMATING FORCE:

		Ini	tial		After 25 Cycles			
	M	ating	Uni	mating	М	ating	Uni	mating
	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)
Minimum	35.27	7.93	14.19	3.19	39.85	8.96	15.61	3.51
Maximum	43.06	9.68	16.55	3.72	54.84	12.33	25.49	5.73
Average	38.87	8.74	15.36	3.45	46.11	10.37	20.64	4.64
St Dev	2.44	0.55	0.92	0.21	5.44	1.22	3.75	0.84
Count	8	8	8	8	8	8	8	8
	After 50 Cycles				After 75 Cycles			
	М	ating	Unmating		М	ating	Uni	mating
	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)
Minimum	44.12	9.92	20.46	4.60	46.70	10.50	22.86	5.14
Maximum	61.16	13.75	28.65	6.44	65.30	14.68	31.31	7.04
Average	51.64	11.61	24.59	5.53	55.23	12.42	27.29	6.14
St Dev	5.87	1.32	3.20	0.72	6.60	1.48	3.41	0.77
Count	8	8	8	8	8	8	8	8
		After 10	0 Cycles	•				
	Mating Unmating							

	After 100 Cycles					
	М	ating	Unmating			
	Newtons	Force (Lbs)	Newtons	Force (Lbs)		
Minimum	50.00	11.24	24.46	5.50		
Maximum	67.52	15.18	33.09	7.44		
Average	57.81	13.00	29.35	6.60		
St Dev	6.60	1.48	3.60	0.81		
Count	8	8	8	8		

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD			
Part description: PCIE/CARD				

MATING-UNMATING FORCE:
Mating-Unmating Basic (PCIE-036-02-F-D-TH /EDGE CARD 0.068")

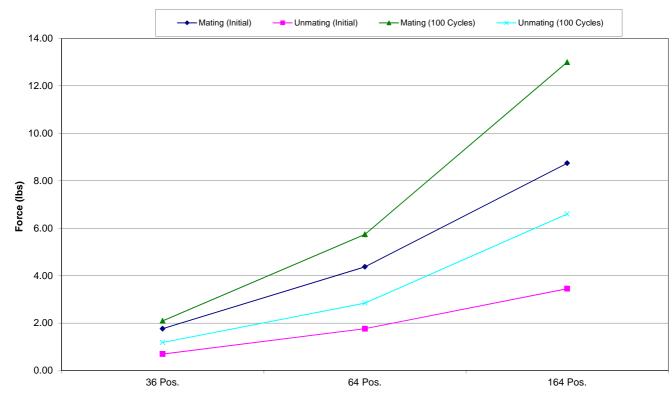
		Ini	tial		After 25 Cycles				
	M	ating	Uni	mating	M	ating	Uni	mating	
	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	
Minimum	7.21	1.62	2.00	0.45	6.89	1.55	2.89	0.65	
Maximum	9.25	2.08	3.51	0.79	10.41	2.34	5.03	1.13	
Average	7.82	1.76	3.05	0.69	8.10	1.82	3.96	0.89	
St Dev	0.73	0.16	0.46	0.10	1.29	0.29	0.73	0.16	
Count	8	8	8	8	8	8	8	8	
		After 50 Cycles				After 75 Cycles			
	М	ating	Uni	mating	М	ating	Uni	mating	
	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	
Minimum	6.76	1.52	3.11	0.70	6.76	1.52	3.34	0.75	
Maximum	11.08	2.49	6.00	1.35	11.74	2.64	6.58	1.48	
Average	8.52	1.92	4.50	1.01	8.91	2.00	4.87	1.10	
St Dev	1.74	0.39	0.86	0.19	1.93	0.43	0.97	0.22	
				l		l -			
Count	8	8	8	8	8	8	8	8	

	After 100 Cycles					
	М	ating	Unmating			
	Newtons	Force (Lbs)	Newtons	Force (Lbs)		
Minimum	6.94	1.56	3.60	0.81		
Maximum	12.19	2.74	6.98	1.57		
Average	9.29	2.09	5.23	1.18		
St Dev	2.04	0.46	1.03	0.23		
Count	8	8	8	8		

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD				
Part description: PCIE/CARD					

Mating\Unmating Force Comparison

Mating/Unmating Data for 36, 64 and 164 Position PCIE/CARD



Number of Terminals per Row

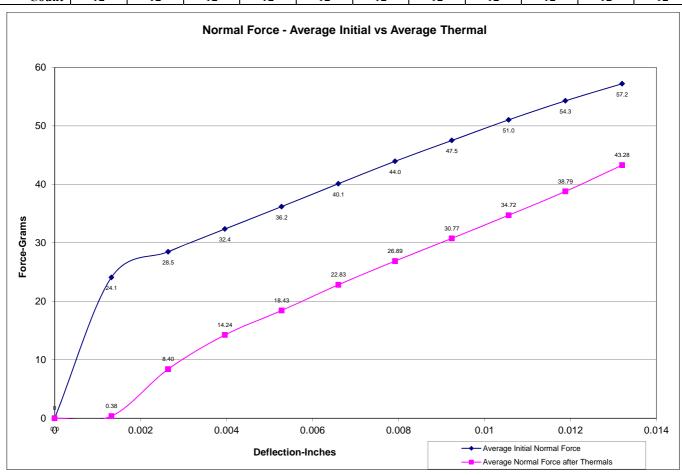
Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD				
Part description: PCIE/CARD					

NORMAL FORCE (FOR CONTACTS TESTED IN THE HOUSING):

- 1) Calibrated force gauges are used along with computer controlled positioning equipment.
- 2) For Normal force 8-10 measurements are taken and the averages reported.

				Def	flections in	inches Fo	rces in Gra	ıms			
Initial	0.0013	0.0026	0.0040	0.0053	0.0066	0.0079	0.0092	0.0106	0.0119	0.0132	SET
Averages	24.09	28.48	32.37	36.19	40.12	43.95	47.51	51.03	54.28	57.21	0.0001
Min	16.60	20.30	23.80	27.80	31.80	35.70	39.40	43.40	46.80	49.80	0.0000
Max	32.00	38.70	42.60	46.80	50.30	54.00	57.50	60.80	63.50	64.70	0.0003
St. Dev	5.062	5.712	5.716	5.829	5.684	5.605	5.601	5.408	5.287	4.983	0.0001
Count	12	12	12	12	12	12	12	12	12	12	12

After				Def	lections in	inches Fo	rces in Gra	ams			
Thermals	0.0013	0.0026	0.0040	0.0053	0.0066	0.0079	0.0092	0.0106	0.0119	0.0132	SET
Averages	0.38	8.40	14.24	18.43	22.83	26.89	30.77	34.72	38.79	43.28	0.0018
Min	-0.10	5.80	10.60	14.90	19.40	23.10	26.70	30.70	34.80	39.00	0.0004
Max	3.90	13.30	19.20	23.00	27.60	31.80	35.70	39.40	43.50	48.10	0.0024
St. Dev	1.115	2.481	3.322	3.225	3.240	3.400	3.406	3.372	3.384	3.435	0.0005
Count	12	12	12	12	12	12	12	12	12	12	12



Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD				
Part description: PCIE/CARD					

INSULATION RESISTANCE (IR):

		Pin to Pin				
	Mated	Unmated	Unmated			
Minimum	PCIE/Card	PCIE	Card			
Initial	10000	10000	Not Tested			
Thermal	10000	10000	Not Tested			
Humidity	7636	7863	Not Tested			

		Row to Row				
	Mated	Unmated	Unmated			
Minimum	PCIE/Card	PCIE	Card			
Initial	10000	10000	Not Tested			
Thermal	10000	10000	Not Tested			
Humidity	10000	10000	Not Tested			

DIELECTRIC WITHSTANDING VOLTAGE (DWV):

Voltage Rating Summary				
Minimum	PCIE/Card			
Break Down Voltage	875			
Test Voltage	660			
Working Voltage	215			

	Pin to Pin
Initial Test Voltage	Passed
After Thermal Test Voltage	Passed
After Humidity Test Voltage	Passed

Row to Row				
Initial Test Voltage	Passed			
After Thermal Test Voltage	Passed			
After Humidity Test Voltage	Passed			

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD				
Part description: PCIE/CARD					

LLCR Thermal Aging Group

- 1) A total of 192 points were measured.
- 2) EIA-364-23, Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets.
- 3) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 4) The following guidelines are used to categorize the changes in LLCR as a result from stressing.
 - a. <= +5.0 mOhms:-----Stable
 - b. +5.1 to +10.0 mOhms: ------Minor
 - c. +10.1 to +15.0 mOhms:------Acceptable
 - d. +15.1 to +50.0 mOhms:------Marginal
 - e. +50.1 to +2000 mOhms-------Unstable
 - f. >+2000 mOhms: -----Open Failure

PCIE-064-02-F-D-TH /EDGE CARD 0.056"

	LLCR Measur	rement Summaries	s by Pin Ty	<i>у</i> ре
Date	4/3/2015	4/14/2015		
Room Temp (Deg C)	24	22		
Rel Humidity (%)	58	43		
Technician	Kason He	Kason He		
mOhm values	Actual	Delta	Delta	Delta
	Initial	Thermal		
Card 0.056"	P	Pin Type 1: Signa	il	
Average	10.26	1.43		
St. Dev.	0.63	0.97		
Min	8.81	0.01		
Max	11.87	4.29		
Summary Count	192	192		
Total Count	192	192		

LLCR Delta Count by Category						
	Stable	Minor	Acceptable	Marginal	Unstable	Open
mOhms	<=5	>5 & <=10	>10 & <=15	>15 & <=50	>50 & <=1000	>1000
Thermal	192	0	0	0	0	0

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD				
Part description: PCIE/CARD					

PCIE-064-02-F-D-TH /EDGE CARD 0.068"

	LLCR Meas	surement Summarie	es by Pin T	уре
Date	4/3/2015	4/14/2015		
Room Temp (Deg C)	24	22		
Rel Humidity (%)	58	43		
Technician	Kason He	Kason He		
mOhm values	Actual	Delta	Delta	Delta
	Initial	Thermal		
Card 0.068"		Pin Type 1: Sign	al	
Average	9.49	1.02		
St. Dev.	0.50	0.74		
Min	8.33	0.01		
Max	10.83	3.73		
Summary Count	192	192		
Total Count	192	192		

LLCR Delta Count by Category						
	Stable	Minor	Acceptable	Marginal	Unstable	Open
mOhms	<=5	>5 & <=10	>10 & <=15	>15 & <=50	>50 & <=1000	>1000
Thermal	192	0	0	0	0	0

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD		
Part description: PCIE/CARD			

LLCR Mating/Unmating Durability Group

- 1). A total of 192 points were measured.
- 2). EIA-364-23, Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets.
- 3). A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 4). The following guidelines are used to categorize the changes in LLCR as a result from stressing.
 - a. <= +5.0 mOhms:-----Stable
 - b. +5.1 to +10.0 mOhms: ------Minor
 - c. +10.1 to +15.0 mOhms: ------Acceptable
 - d. +15.1 to +50.0 mOhms: -------Marginal
 - e. +50.1 to +2000 mOhms------Unstable
 - f. > +2000 mOhms:------Open Failure

PCIE-064-02-F-D-TH /EDGE CARD 0.056"

	LLCR	Measurement S	Summaries by Pir	туре
Date	3/23/2015	3/25/2015	4/7/2015	4/22/2015
Room Temp (Deg C)	21	23	22	21
Rel Humidity (%)	50	51	56	55
Technician	Kason He	Kason He	Kason He	Kason He
mOhm values	Actual	Delta	Delta	Delta
	Initial	100 Cycles	Therm Shck	Humidity
Card 0.056"		Pin Type	1: Signal	·
Card 0.056" Average	9.84	Pin Type 0.50	1: Signal	2.05
	9.84 0.55			2.05 1.50
Average		0.50	1.31	
Average St. Dev.	0.55	0.50 0.48	1.31 0.70	1.50
Average St. Dev. Min	0.55 8.78	0.50 0.48 0.00	1.31 0.70 0.02	1.50 0.01

		LLCR	Delta Count by	Category		
	Stable	Minor	Acceptable	Marginal	Unstable	Open
mOhms	<=5	>5 & <=10	>10 & <=15	>15 & <=50	>50 & <=1000	>1000
100 Cycles	192	0	0	0	0	0
Therm Shck	192	0	0	0	0	0
Humidity	189	3	0	0	0	0

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD		
Part description: PCIE/CARD			

PCIE-064-02-F-D-TH /EDGE CARD 0.068"

	LLCR	Measurement	Summaries by P	in Type
Date	3/24/2015	3/25/2015	4/7/2015	4/22/2015
Room Temp (Deg C)	23	23	22	21
Rel Humidity (%)	52	51	56	55
Technician	Kason He	Kason He	Kason He	Kason He
mOhm values	Actual	Delta	Delta	Delta
	Initial	100 Cycles	Therm Shck	Humidity
Card 0.068"	Pin Type 1: Signal			
Average	9.76	0.62	0.89	2.01
St. Dev.	0.77	0.58	0.68	1.67
Min	7.93	0.00	0.00	0.00
Max	11.35	3.09	3.35	6.44
Summary Count	192	192	192	192
Total Count	192	192	192	192

	LLCR Delta Count by Category					
	Stable	Minor	Acceptable	Marginal	Unstable	Open
mOhms	<=5	>5 & <=10	>10 & <=15	>15 & <=50	>50 & <=1000	>1000
100 Cycles	192	0	0	0	0	0
Therm Shck	192	0	0	0	0	0
Humidity	181	11	0	0	0	0

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD		
Part description: PCIE/CARD			

LLCR Gas Tight Group

- 1) A total of 192 points were measured.
- 2) EIA-364-23, Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets.
- 3) A computer program, LLCR 221.exe, ensures repeatability for data acquisition.
- 4) The following guidelines are used to categorize the changes in LLCR as a result from stressing.
 - a. <= +5.0 mOhms:-----Stable
 - b. +5.1 to +10.0 mOhms: ------Minor
 - c. +10.1 to +15.0 mOhms:------Acceptable
 - d. +15.1 to +50.0 mOhms:------Marginal
 - e. +50.1 to +2000 mOhms:------Unstable
 - f. >+2000 mOhms: ------Open Failure

PCIE-064-02-F-D-TH /EDGE CARD 0.056"

	LLCR Mea	s by Pin Ty	<i>r</i> pe	
Date	4/7/2015	4/27/2015		
Room Temp (Deg C)	22	21		
Rel Humidity (%)	56	61		
Technician	Kason He	Kason He		
mOhm values	Actual	Delta	Delta	Delta
	Initial	Acid Vapor		
		Pin Type 1: Signa	ıl	
Average	10.54	0.95		
St. Dev.	0.71	0.74		
Min	8.54	0.00		
Max	11.96	3.43		
Summary Count	192	192		
Total Count	192	192		

		LLCR	Delta Count by	Category		
	Stable	Minor	Acceptable	Marginal	Unstable	Open
mOhms	<=5	>5 & <=10	>10 & <=15	>15 & <=50	>50 & <=1000	>1000
Acid Vapor	192	0	0	0	0	0

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD		
Part description: PCIE/CARD			

LLCR Shock & Vibration Group

- 1) A total of 192 points were measured.
- 2) EIA-364-23, Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets.
- 3) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 4) The following guidelines are used to categorize the changes in LLCR as a result from stressing.
 - a. <= +5.0 mOhms: -----Stable
 - b. +5.1 to +10.0 mOhms: ------Minor
 - c. +10.1 to +15.0 mOhms:------Acceptable
 - d. +15.1 to +50.0 mOhms: -------Marginal
 - e. +50.1 to +2000 mOhms-------Unstable
 - f. >+2000 mOhms: -----Open Failure

PCIE-064-02-F-D-TH /EDGE CARD 0.056"

	LLCR Measurement Summaries by Pin Type			
Date	5/26/2015	5/27/2015		
Room Temp (Deg C)	21	22		
Rel Humidity (%)	44	42		
Technician	Troy Cook	Troy Cook		
mOhm values	Actual	Delta	Delta	Delta
	Initial	Shock-Vib		
	Pin Type 1: Signal			
Average	9.12	0.44		
St. Dev.	0.47	0.44		
Min	8.11	0.00		
Max	11.27	2.77		
Summary Count	192	192		
Total Count	192	192		

LLCR Delta Count by Category						
	Stable	Minor	Acceptable	Marginal	Unstable	Open
mOhms	<= 5	>5 & <=10	>10 & <=15	>15 & <=50	>50 & <=1000	>1000
Shock-Vib	192	0	0	0	0	0

Nanosecond Event Detection:

Shock and Vibration Event Detection Summary			
Contacts tested	60		
Test Condition	C, 100g's, 6ms, Half-Sine		
Shock Events	0		
Test Condition	V-B, 7.56 rms g		
Vibration Events	0		
Total Events	0		

Tracking Code: 478081_Report_Rev_1	Part #: PCIE-064-02-F-D-TH/EDGE CARD				
Part description: PCIE/CARD					

PCIE-064-02-F-D-TH /EDGE CARD 0.068"

	LLCR Measurement Summaries by Pin Type			
Date	4/29/2015	5/15/2015		
Room Temp (Deg C)	22	22		
Rel Humidity (%)	34	39		
Technician	Troy Cook	Troy Cook		
mOhm values	Actual	Delta	Delta	Delta
	Initial	Shock-Vib		
	Pin Type 1: Signal			
Average	9.21	0.35		
St. Dev.	0.44	0.48		
Min	8.12	0.00		
Max	10.70	4.26		
Summary Count	192	192		
Total Count	192	192		

LLCR Delta Count by Category						
	Stable	Minor	Acceptable	Marginal	Unstable	Open
mOhms	<=5	>5 & <=10	>10 & <=15	>15 & <=50	>50 & <=1000	>1000
Shock-Vib	192	0	0	0	0	0

Tracking Code: 478081 Report Rev 1

Part description: PCIE/CARD

EQUIPMENT AND CALIBRATION SCHEDULES

Equipment #: HZ-TCT-01

Description: Normal force analyzer **Manufacturer:** Mecmesin Multitester **Model:** Mecmesin Multitester 2.5-i

Serial #: 08-1049-04

Accuracy: Last Cal: 4/25/2014, Next Cal: 4/24/2015

Equipment #: HZ-OV-01 Description: Oven Manufacturer: Huida Model: CS101-1E Serial #: CS101-1E-B

Accuracy: Last Cal: 12/11/2014, Next Cal: 12/10/2015

Equipment #: HZ-THC-01 **Description:** Humidity transmitter **Manufacturer:** Thermtron

Model: SM-8-8200 Serial #: 38846

Accuracy: Last Cal: 2/26/2015, Next Cal: 2/25/2016

Equipment #: HZ-HPM-01 Description: NA9636H Manufacturer: Ainuo

Model: 6031A **Serial #:** 089601091

Accuracy: Last Cal: 3/5/2015, Next Cal: 3/4/2016

Equipment #: HZ-MO-05 Description: Micro-ohmmeter Manufacturer: Keithley

Model: 3706 **Serial #:** 1285188

Accuracy: Last Cal: 11/13/2014, Next Cal: 11/12/2015

Equipment #: HZ-TSC-01

Description: Vertical Thermal Shock Chamber

Manufacturer: Cincinnatti Sub Zero

Model: VTS-3-6-6-SC/AC Serial #: 10-VT14994 Accuracy: See Manual

... Last Cal: 06/26/2014, Next Cal: 06/25/2015

Equipment #: HZ-PS-01

Description: 120 Amp Power Supply

Manufacturer: Agilent Model: 6031A PS Serial #: MY41000982 Accuracy: See Manual

... Last Cal: 07/02/2014, Next Cal: 07/01/2015

Part description: PCIE/CARD

EQUIPMENT AND CALIBRATION SCHEDULES Continued

Equipment #: HZ-MO-01

Description: Multimeter /Data Acquisition System

Manufacturer: Keithley

Model: 2700 Serial #: 1199807 Accuracy: See Manual

... Last Cal: 07/02/2014, Next Cal: 07/01/2015

Equipment #: MO-11

Description: Switch/Multimeter **Manufacturer:** Keithley

Model: 3706 Serial #: 120169 Accuracy: See Manual

... Last Cal: 08/21/2014, Next Cal: 08/21/2015

Equipment #: SVC-01

Description: Shock & Vibration Table

Manufacturer: Data Physics **Model:** LE-DSA-10-20K

Serial #: 10037 Accuracy: See Manual

... Last Cal: 11/31/2014, Next Cal: 11/31/2015

Equipment #: ACLM-01
Description: Accelerometer
Manufacturer: PCB Piezotronics

Model: 352C03 Serial #: 115819 Accuracy: See Manual

... Last Cal: 07/09/2014, Next Cal: 07/09/2015

Equipment #: ED-03

Description: Event Detector

Manufacturer: Analysis Tech

Model: 32EHD Serial #: 1100604 Accuracy: See Manual

... Last Cal: 06/04/2014, Next Cal: 06/04/2015